

## Embedded Orientation Detection Using the MMA8451, 2, 3Q

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### 1.0 Introduction

Many handheld devices integrate consumer grade accelerometers into mobile handsets. By incorporating more intelligence from hand gestures, the accelerometer has had a significant impact on user interaction with handsets. Minimizing the need for buttons has changed the design of the handset interface by including motion inputs such as flicks, taps, shakes and varied orientations, all of which are interpreted by handsets. Further, handsets can provide entertainment in terms of motion-based games. Most motionbased hand gestures and games are derived from analyses of static acceleration. These analyses, in turn, are based on gravity to determine the change in tilt angles.

Accelerometers provide a new way for navigating, scrolling, and viewing information. With these sensors, even user activity levels can be monitored, e.g. while carrying the device and by counting steps.

This application note targets the portrait/landscape orientation detection feature which has become standard in many handheld electronic devices. Additionally, this application note aims to explain uses as well as highlight some of the challenges of designing an embedded algorithm into the sensor. Included in content, the embedded settings of the MMA8451, 2, 3Q are explained and detailed for implementation.
Note: Although embedded algorithms typically lack flexibility, the algorithm of the MMA8451, 2, 3Q was designed to offer a variety of settings for the user.

### 1.1 Key Words

Accelerometer, Static Acceleration, Tilt Angles, Portrait/Landscape Orientation, Embedded Algorithm
MMA8450Q, Z-Angle Lockout, XYZ Output Data, Low-
Current Consumption, Motion and Tap Detection, Design
Flexibility, Hysteresis, 3-axis Accelerometer, Offset
Considerations, Sample Rate, Debounce

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### 1.2 Summary

A. The key advantage of having the orientation detection as an embedded algorithm is that it permits the user to set up an interrupt service routine to get an update when the orientation has changed
B. The status register is only read when a change has occurred.
C. Less processing is required on the microcontroller than having to poll the XYZ registers and calculate out the corresponding orientations.
D. There is a choice of up to 10 different trip angles from Portrait to Landscape with hysteresis from $0^{\circ}$ to $24^{\circ}$.
E. There are four front/back trip angles and there are 8 different settings for the Z-Angle lockout from $14^{\circ}$ to $42^{\circ}$.
F. The orientation detection can be used at 8 different sample rates and can automatically switch from a higher rate to a lower rate with the ability to adjust the debounce counter to make the transitions smooth without long delays.
G. The debounce counter is changeable in either the active or standby mode to allow for adjustments after the part transitions from wake to sleep mode.

### 2.0 MMA8451, 2, 3Q Consumer 3-axis Accelerometer 3 by 3 by 1 mm

The MMA8451, $2,3 \mathrm{Q}$ has a selectable dynamic range of $\pm 2 \mathrm{~g}, \pm 4 \mathrm{~g}, \pm 8 \mathrm{~g}$. The device has eight different output data rates, selectable high-pass filter cutoff frequencies, and high-pass filtered data. The available resolution of the data and the embedded features is dependant on the specific device.
Note: The MMA8450Q has a different memory map and has a slightly different pinout configuration.


Figure 1. MMA8451, 2, 3Q Consumer 3-axis Accelerometer 3 by 3 by 1 mm

### 2.1 Output Data, Sample Rates and Dynamic Ranges of all Three Products

### 2.1.1 MMA8451Q

1. 14-bit data
$\mathbf{2 g}$ ( 4096 counts $/ \mathrm{g}=0.25 \mathrm{mg} / \mathrm{LSB}) \mathbf{4 g}$ (2048 counts/g $=0.5 \mathrm{mg} / \mathrm{LSB}) \mathbf{8 g}(1024$ counts $/ \mathrm{g}=1 \mathrm{mg} / \mathrm{LSB})$
2. 8 -bit data
$\mathbf{2 g}(64$ counts $/ \mathrm{g}=15.6 \mathrm{mg} / \mathrm{LSB}) \mathbf{4 g}$ ( 32 counts $/ \mathrm{g}=31.25 \mathrm{mg} / \mathrm{LSB}$ ) $\mathbf{8 g}$ ( 16 counts $/ \mathrm{g}=62.5 \mathrm{mg} / \mathrm{LSB}$ )
3. Embedded 32 sample FIFO (MMA8451Q)

### 2.1.2 MMA8452Q

1. 12-bit data
$\mathbf{2 g}$ ( 1024 counts $/ \mathrm{g}=1 \mathrm{mg} / \mathrm{LSB}$ ) $\mathbf{4 g}$ ( 512 counts $/ \mathrm{g}=2 \mathrm{mg} / \mathrm{LSB}) \mathbf{8 g}(256$ counts $/ \mathrm{g}=3.9 \mathrm{mg} / \mathrm{LSB})$
2. 8-bit data
$\mathbf{2 g}$ ( 64 counts $/ \mathrm{g}=15.6 \mathrm{mg} / \mathrm{LSB}) \mathbf{4 g}$ ( 32 counts $/ \mathrm{g}=31.25 \mathrm{mg} / \mathrm{LSB}$ ) $\mathbf{8 g}$ ( 16 counts $/ \mathrm{g}=62.5 \mathrm{mg} / \mathrm{LSB}$ )

### 2.1.3 MMA8453Q Note: No HPF Data

1. 10-bit data
$\mathbf{2 g}$ ( 256 counts $/ \mathrm{g}=3.9 \mathrm{mg} / \mathrm{LSB}$ ) $\mathbf{4 g}$ ( 128 counts $/ \mathrm{g}=7.8 \mathrm{mg} / \mathrm{LSB}$ ) $\mathbf{8 g}$ ( 64 counts $/ \mathrm{g}=15.6 \mathrm{mg} / \mathrm{LSB}$ )
2. 8-bit data
$\mathbf{2 g}$ ( 64 counts $/ \mathrm{g}=15.6 \mathrm{mg} / \mathrm{LSB}$ ) $\mathbf{4 g}$ ( 32 counts $/ \mathrm{g}=31.25 \mathrm{mg} / \mathrm{LSB}$ ) $\mathbf{8 g}$ ( 16 counts $/ \mathrm{g}=62.5 \mathrm{mg} / \mathrm{LSB}$ )

### 2.2 Fundamentals of Tilt for Orientation Detection

The accelerometer sensor is used to add intelligence into handheld devices. The accelerometer can detect the orientation of the device which can be used to alert the handheld device to update the image based on the sensor orientation data. This is implemented so that images on the screen always appear upright to the user. Figure 2 shows all the different orientations. More detail of the different orientations will be discussed in the following sections.


Figure 2. Direction of the Detectable Accelerations

PU (Portrait Up, Front) Default and Initial Orientation

PU (Portrait Up, Back)


PD (Portrait Down, Back)


LR (Landscape Right, Back)


Figure 3. Landscape to Portrait Screen Orientation Change Positions
This application is based on tilt sensing. For more details on tilt sensing, please refer to Freescale application note, AN3461. Tilt is a static measurement. The force of gravity is used as an input to determine the orientation of an object calculating the degree of tilt. The accelerometer will experience acceleration in the range from -1 g to +1 g through $180^{\circ}$ of tilt. Figure 4 is a graphical representation of the change in acceleration of both the X and the Y -axis.


Figure 4. Reference Frame for Tilt Note: $1 \mathrm{~g}=-9.8 \mathrm{~m} / \mathrm{s}^{2}$


Figure 5. Sine Function of the $X$ Output and Cosine Function of the $Y$ Output
Figure 5 demonstrates that it is easy to detect the different orientations of the device:

- At $0^{\circ}$ the device would be in the Portrait Up position
- At $90^{\circ}$ the device is at the Landscape Left position
- At $180^{\circ}$ the device is in the Portrait Down position
- At $270^{\circ}$ the device is in the Landscape Right position

The ideal trip angle to change between states, would be at $45^{\circ}$, which is in the middle of the two states.

### 3.0 Challenges and Advanced Features for Orientation Detection

Embedded algorithms are typically somewhat restrictive. However, there are enhancements that have been made to allow more flexibility in the design of the MMA8451, 2, 3Q without the need to poll the acceleration XYZ outputs and analyze data using the processor. With a larger demand for sensors in handheld devices, this intelligence is expected by users.

### 3.1 Front and Back Detection

When the device is facing up, it is considered in the front view and when the device is facing down, it is considered in the back view as shown in Figure 6.


Figure 6. Front/Back Trip Point

The angle for switching between front and back is calculated by taking the inverse sine of the acceleration of the Z-axis.

$$
\theta=\sin ^{-1}\left(a_{z}\right)
$$

The MMA8451Q allows the user to choose between four different Back to Front/Front to Back trip angles as described below. This allows for more flexibility in the usability for the application as compared to an embedded design that would typically only allow for one trip angle. From the following options, the user can select where this trip point should be.

| $10^{\circ}: Z<80^{\circ}$ and $Z>280^{\circ}$ Back | $Z>100^{\circ}$ and $Z<260^{\circ}$ Front |
| :--- | :--- |
| $15^{\circ}: Z<75^{\circ}$ and $Z>285^{\circ}$ Back | $Z>105^{\circ}$ and $Z<255^{\circ}$ Front |
| $20^{\circ}: Z<70^{\circ}$ and $Z>290^{\circ}$ Back | $Z>110^{\circ}$ and $Z<250^{\circ}$ Front |
| $25^{\circ}: Z<65^{\circ}$ and $Z>295^{\circ}$ Back | $Z>115^{\circ}$ and $Z<245^{\circ}$ Front |

Note: If the first position of the device is in-between the front/back trip angles then the MMA8451, 2, 3Q will not know which state it is in and will assume no state until the device transitions past the trip point.

### 3.2 Setting the Threshold Angle and the Hysteresis



Figure 7. Setting the Trip Angle

The MMA8451Q allows the user to select a range of 10 different trip angles from $15^{\circ}$ to $75^{\circ}$ with increments of $5^{\circ}$. Figure 7 shows the default angle at $45^{\circ}$. Although the $45^{\circ}$ trip angle seems like the ideal angle between the two states, a usability problem could occur when the device is held near the $45^{\circ}$ angle. A very slight movement can cause the device to flicker slightly above and then below the $45^{\circ}$ angle that could make the screen jump back and forth between portrait and landscape. This issue can be seen particularly when using higher sampling rates without any debounce filtering. This can be entirely avoided by adding in a buffer around the trip threshold. By adding in the hysteresis angle this problem can be avoided. The default hysteresis value is $\pm 14^{\circ}$ as shown above in Figure 7. With the hysteresis built-in the orientation will change from Portrait to Landscape at $31^{\circ}$ and from Landscape to Portrait at $59^{\circ}$. With separate trip points in this manner allows for smooth transitions from one state to the next. The user must tilt the device to $59^{\circ}$ to go from Landscape to Portrait. And then to return immediately to Landscape, the user would rotate the device back to $31^{\circ}$ to make it trip to Landscape. The transition from Portrait to Landscape and Landscape to Portrait is shown in Figure 8.


Figure 8. Changing from Portrait to Landscape

### 3.3 Z-Lockout and Effects on Choosing Two Trip Angles P2L and L2P

The next consideration is the angle of $Z$-axis on which a user holds the mobile device while rotating it to change the image from Portrait to Landscape. The angle at which the image no longer detects the orientation change is referred to as the " $Z$-lockout angle". Based on known functionality of linear accelerometers, it is not possible to rotate the device about the Z-axis and to detect change in acceleration at slow angular speeds as shown in Figure 9.


Figure 9. Image of Z-Lockout, showing no acceleration sensing at low speed
In a 3-axis accelerometer, it is required that acceleration sensed in the $X$ and $Y$ axes must differ by a minimum amount to sense when the tilt angle has met a pre-set condition. When the device is placed on a flat surface and the $Z$ angle is 0 degrees with respect to a line in the direction of the earth's gravity, there is no way to determine the orientation of the device and the screen should stay in the last position. A minimum angle called the "Z-lockout" angle is defined where the last position is held until the device is tilted beyond this limit. Ideally, the X and Y outputs would change from 0 g to 1 g on the X and Y axes as the device rotated if a user held the device perfectly vertical as in image \#1 of Figure 10. However, this is not a very likely scenario. Most users will hold the device from $25^{\circ}-30^{\circ}$ up to $60^{\circ}-75^{\circ}$ from the horizontal as shown in the images below in \#2, \#3 and \#4. Note now that in \#2-\#4, the magnitude of the acceleration of $X$ and $Y$ is now smaller. They are now scaled by the sine of the $Z$-tilt angle.


Figure 10. Examples of How the Z-tilt Angle Affects Scaling on the $X$ and $Y$ Axes

Since the output acceleration of $X$ and $Y$ will be scaled based on the $Z$-axis component, choosing the threshold trip angle is made more difficult. However, the algorithm designed into the MMA8451, 2, 3Q takes into account the Z-lockout range expected. The MMA8451Q Z-lockout angle selections range from $14^{\circ}$ to $42^{\circ}$ with increment changes of approximately $4^{\circ}$. The selection choices for the Z-lockout are the following: Angle $14^{\circ}, 18^{\circ}, 21^{\circ}, 25^{\circ}, 29^{\circ}, 33^{\circ}, 37^{\circ}, 42^{\circ}$. All angles are accurate to about $2^{\circ}$. These values are all settable in the register configuration of the device for the Z-lockout angle. The max and min Z-lockout angles are shown in Figure 11.


Figure 11. Z-Lockout Max and Min Angles

### 3.4 Og Offset Considerations

The accelerometers are trimmed according to sensitivity and offset specifications by adjusting the gain and offset trim codes. Test tolerances are placed on the device during this process. After the accelerometer has been assembled onto a PCB the offset can shift due to package stresses. This ultimately results in the accelerometer appearing to be rotated or tilted relative to the desired reference position. Often this shift is very small and for most applications it will not be noticeable. A larger offset shift of 0.1 g will result in an angle shift of about $5.7^{\circ}$. The algorithm designed into the MMA8451, 2, 3Q has accounted for typical offset shifts seen after board mounting. For more accuracy in setting the trip angles and the lockout angle the calibration registers 0x2F, $0 \times 30$ and $0 \times 31$ can be used. Details on how to calibrate the MMA8451, 2, 3Q can be found in Freescale application note AN4069.

## $3.5 \quad 1 \mathrm{~g}$ Lockout Threshold Settings

When the accelerometer is not moving, the Root Mean Square (RMS) of the acceleration vectors is equal to 1 g . There are many circumstances where users may be jogging or in a train or on a bus where they may be bouncing above 1 g . When the device is experiencing acceleration above a set threshold, the screen orientation should not interpret this as a change and the screen should lock in the last known valid position. The set threshold is 1.25 g in the MMA8451, 2, 3Q.

### 3.6 Sample Rate and Debounce Counter Settings

### 3.6.1 Sample Rate

Some applications may require faster response times such as for transient detection or for tap detection. The portrait/landscape application does not typically require a fast response time and it could be run at 12.5 Hz or 6.25 Hz . The embedded orientation detection will still work in sleep mode (typically lower sample rates from 1.56 Hz to 50 Hz ) in the MMA8451, 2, 3Q. A debounce counter can be set to filter out faster movements and can be changed in either the Standby or Active mode. This creates a delay in the reaction time of the orientation update, which may be desired. The device can be used at a high-sample rate $(400 \mathrm{~Hz})$ to be able to detect fast transitions from the XYZ output data and at the same time the orientation detection update rate can be modified to be much slower by using the debounce counter to filter out fast transitions.

### 3.6.2 Debounce Counter Settings

A debounce counter is often used to improve the reliability of the screen orientation. For example, jittery hands and small vibrations can cause false accelerations, tripping the orientation to change even when nothing has really happened. These false accelerations are smoothed out using a debounce counter to ensure that the orientation has been steady in the new position long enough to warrant a change in position. The MMA8451, $2,3 \mathrm{Q}$ debounce counter is an 8 -bit value which is dependent on the oversampling mode and sample rate. Therefore up to 256 samples can be averaged. The debounce counter will be set for the output data rate value assumed for the active mode but may need to be readjusted if the sample rate changes significantly when the device goes into sleep mode. For this reason the debounce counter is accessible to change while the device is active.
Note: The longer the time set for the debounce counter, the longer the delay. This can significantly slow down the response time.

### 4.0 Details for Configuring the MMA8451, 2, 3Q for Orientation Detection

The MMA8451, 2, 3Q data sheets review in detail the register settings and information on how to configure the angle settings. The intent is not to try to repeat the data sheet but to highlight the registers of interest and explain their use. Refer to the data sheet and use the tables to calculate all the correct angle settings. Table 1 lists the registers of importance for setting up the orientation detection.
Table 1. Registers of Importance for Configuring the Orientation Detection in the in the MMA8451, 2, 3Q

| R\# | Name | Definition | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| OC | INT_SOURCE | Interrupt Status R | SRC_ASLP | SRC_FIFO | SRC_TRANS | SRC_LNDPRT | SRC_PULSE | SRC_FF_MT | - | SRC_DRDY |
| 10 | PL_STATUS | PL Status R | NEWLP | LO | - | - | - | LAPO[1] | LAPO[0] | BAFRO |
| 11 | PL_CFG | PL Configuration R/W | DBCNTM | PL_EN | - | - | - | - | - | - |
| 12 | PL_COUNT | PL Debounce R/W | DBNCE[7] | DBNCE[6] | DBNCE[5] | DBNCE[4] | DDBNCE[3] | DBNCE[2] | DBNCE[1] | DBNCE[0] |
| 13 | PL_BF_ZCOMP | PL Back/Front and Z Compensation R | BKFR[1] | BKFR[0] | - | - | - | ZLOCK[2] | ZLOCK[1] | ZLOCK[0] |
| 14 | P_L_THS_REG | Landscape to Portrait Threshold Setting R | P_L_THS[4] | P_L_THS[3] | P_L_THS[2] | P_L_THS[1] | P_L_THS[0] | HYS[2] | HYS[1] | HYS[0] |
| 2D | CTRL_REG4 | Control Reg4 R/W (Interrupt Enable Map) | INT_EN_ASLP | INT_EN_FIFO | INT_EN_TRANS | INT_EN_LNDPRT | INT_EN_PULSE | INT_EN_FF_MT | - | INT_EN_DRDY |
| 2 E | CTRL_REG5 | Control Reg5 R/W (Interrupt Configuration) | INT_CFG_ASLP | INT_CFG_FIFO | INT_CFG_TRANS | INT_CFG_LNDPRT | INT_CFG_PULSE | INT_CFG_FF_MT | - | INT_CFG_DRDY |

### 4.1 Example Steps for Implementing the Embedded Orientation Detection

Step 1: Put the part into Standby Mode
CTRL_REG1_Data = IIC_RegRead(0x2A); //read contents of register
CTRL_REG1_Data\& = 0xFE; //Set last bit to 0 .
IIC_RegWrite(0x2A, CTRL_REG1_Data); //write the updated value in CTRL_REG1
Step 2: Set the data rate to 50 Hz (for example, but can choose any sample rate).
CTRL_REG1_Data = IIC_RegRead(0x2A); //Note: Can combine this step with above
CTRL_REG1_Data\& = 0xC7; //Clear the sample rate bits
CTRL_REG1_Data | = 0x20; //Set the sample rate bits to 50 Hz
IC_RegWrite(0x2A, CTRL_REG1_Data); //Write updated value into the register.
Step 3: Set the PL_EN bit in Register $0 \times 11$ PL_CFG. This will enable the orientation detection. PLCFG_Data $=$ IIC_RegRead ( $0 \times 11$ );
PLCFG_Data $\mid=0 \times 40$;
IIC_RegWrite(0x11, PLCFG_Data);
Step 4: Set the Back/Front Angle trip points in register 0x13 following the table in the data sheet.
NOTE: This register is readable in all versions of MMA845xQ but it is only modifiable in the MMA8451Q.
PL_BF_ZCOMP_Data = IIC_RegRead(0x13);
PL_BF_ZCOMP_Data\& $=0 \times 3 F$; //Clear bit 7 and 6
Select one of the following to set the B/F angle value:
PL_BF_ZCOMP_Data $\mid=0 \times 00$; //This does nothing additional and keeps bits [7:6] = 00
PL_BF_ZCOMP_Data | $=0 \times 40$; //Sets bits[7:6] $=01$
PL_BF_ZCOMP_Data | $=0 \times 80$; //Sets bits[7:6] $=02$
PL_BF_ZCOMP_Data | $=0 \times$ C0; //Sets bits[7:6] $=03$
IIC_RegWrite(0x13, PL_BF_ZCOMP_Data); //Write in the updated Back/Front Angle
Step 5: Set the Z-Lockout angle trip point in register $0 \times 13$ following the table in the data sheet.
NOTE: This register is readable in all versions of MMA845xQ but it is only modifiable in the MMA8451Q.

PL_BF_ZCOMP_Data = IIC_RegRead(0x1C); //Read out contents of the register (can be read by all versions of MMA845xQ)
The remaining parts of this step only apply to MMA8451Q
PL_BF_ZCOMP_Data\& = 0xF8; //Clear the last three bits of the register

Select one of the following to set the Z-lockout value
PL_BF_ZCOMP_Data | = 0x00; //This does nothing additional but the Z-lockout selection will remain at $14^{\circ}$
PL_BF_ZCOMP_Data | = 0x01; //Set the Z-lockout angle to $18^{\circ}$
PL_BF_ZCOMP_Data | = 0x02; //Set the Z-lockout angle to $21^{\circ}$
PL_BF_ZCOMP_Data | = 0x03; //Set the Z-lockout angle to $25^{\circ}$
PL_BF_ZCOMP_Data | = 0x04; //Set the Z-lockout angle to $29^{\circ}$
PL_BF_ZCOMP_Data | = 0x05; //Set the Z-lockout angle to $33^{\circ}$
PL_BF_ZCOMP_Data | = 0x06; //Set the Z-lockout angle to $37^{\circ}$
PL_BF_ZCOMP_Data | = 0x07; //Set the Z-lockout angle to $42^{\circ}$
IIC_RegWrite(0x13, PL_BF_ZCOMP_Data); //Write in the updated Z-lockout angle
Step 6: Set the Trip Threshold Angle
NOTE: This register is readable in all versions of MMA845xQ but it is only modifiable in the MMA8451Q.
Select the angle desired in the table, and,
Enter in the values given in the table for the corresponding angle.
Refer to Figure 7 for the reference frame of the trip angles.
P_L_THS_Data = IIC_RegRead(0x14); (can be read by all versions of MMA845xQ)
The remaining parts of this step only apply to MMA8451Q
P_L_THS_Data\& $=0 \times 07$; //Clear the Threshold values
Choose one of the following options
P_L_THS_Data | $=(0 \times 07) \ll 3$; //Set Threshold to $15^{\circ}$
P_L_THS_Data | $=(0 \times 09) \ll 3$; //Set Threshold to $20^{\circ}$
P_L_THS_Data | $=(0 \times 0 \mathrm{C}) \ll 3$; //Set Threshold to $30^{\circ}$
P_L_THS_Data | $=(0 x 0 D) \ll 3$; //Set Threshold to $35^{\circ}$
P_L_THS_Data | = (0x0F)<<3; //Set Threshold to $40^{\circ}$
P_L_THS_Data | $=(0 \times 10) \ll 3$; //Set Threshold to $45^{\circ}$
P_L_THS_Data | = (0x13)<<3; //Set Threshold to $55^{\circ}$
P_L_THS_Data | $=(0 \times 14) \ll 3$; //Set Threshold to $60^{\circ}$
P_L_THS_Data | $=(0 \times 17) \ll 3$; //Set Threshold to $70^{\circ}$
P_L_THS_Data | $=(0 \times 19) \ll 3$; //Set Threshold to $75^{\circ}$
IIC_RegWrite(0x14, P_L_THS_Data);
Step 7: Set the Hysteresis Angle
NOTE: This register is readable in all versions of MMA845xQ but it is only modifiable in the MMA8451Q.
Select the hysteresis value based on the desired final trip points (threshold + hysteresis)
Enter in the values given in the table for that corresponding angle.
Note: Care must be taken. Review the final resulting angles. Make sure there isn't a resulting trip value greater than 90 or less than 0.
The following are the options for setting the hysteresis.
P_L_THS_Data = IIC_RegRead(0x14);
NOTE: The remaining parts of this step only apply to the MMA8451Q.
P_L_THS_Data\& = 0xF8; //Clear the Hysteresis values
P_L_THS_Data | = 0x01; //Set Hysteresis to $\pm 4^{\circ}$
P_L_THS_Data | = 0x02; //Set Threshold to $\pm 7^{\circ}$
P_L_THS_Data | = 0x03; //Set Threshold to $\pm 11^{\circ}$
P_L_THS_Data | = 0x04; //Set Threshold to $\pm 14^{\circ}$
P_L_THS_Data | = 0x05; //Set Threshold to $\pm 17^{\circ}$
P_L_THS_Data | $=0 \times 06$; //Set Threshold to $\pm 21^{\circ}$
P_L_THS_Data | = 0x07; //Set Threshold to $\pm 24^{\circ}$
IIC_RegWrite(0x14, P_L_THS_Data);
Step 8: Register 0x2D, Control Register 4 configures all embedded features for interrupt detection.
To set this device up to run an interrupt service routine:
Program the Orientation Detection bit in Control Register 4.
Set bit 4 to enable the orientation detection "INT_EN_LNDPRT".
CTRL_REG4_Data = IIC_RegRead(0x2D); //Read out the contents of the register

CTRL_REG4_Data | = 0x10; //Set bit 4
IIC_RegWrite(0x2D, CTRL_REG4_Data); //Set the bit and write into CTRL_REG4
Step 9: Register 0x2E is Control Register 5 which gives the option of routing the interrupt to either INT1 or INT2
Depending on which interrupt pin is enabled and configured to the processor:
Set bit 4 "INT_CFG_LNDPRT" to configure INT1, or,
Leave the bit clear to configure INT2.
CTRL_REG5_Data = IIC_RegRead(0x2E);
In the next two lines choose to clear bit 4 to route to INT2 or set bit 4 to route to INT1
CTRL_REG5_Data\& $=\mathbf{0 x E F}$; //Clear bit 4 to choose the interrupt to route to INT2
CTRL_REG5_Data | = 0x10; //Set bit 4 to choose the interrupt to route to INT1
IIC_RegWrite(0x2E, CTRL_REG5_Data); //Write in the interrupt routing selection
Step 10: Set the debounce counter in register $0 \times 12$
This value will scale depending on the application-specific required ODR.
If the device is set to go to sleep, reset the debounce counter before the device goes to sleep. This setting helps avoid long delays since the debounce will always scale with the current sample rate. The debounce can be set between $50 \mathrm{~ms}-100 \mathrm{~ms}$ to avoid long delays.
IIC_RegWrite(0x12, 0x05); //This sets the debounce counter to 100 ms at 50 Hz
Step 11: Put the device in Active Mode
CTRL_REG1_Data = IIC_RegRead(0x2A); //Read out the contents of the register
CTRL_REG1_Data | = 0x01; //Change the value in the register to Active Mode.
IIC_RegWrite(0x2A, CTRL_REG1_Data); //Write in the updated value to put the device in Active Mode
Step 12: Write a Service Routine to Service the Interrupt
Register 0x0C gives the status of any of the interrupts that are enabled in the entire device.

- An interrupt service routine must be set to handle enabling and then clearing of the interrupts. Register $0 \times 0 \mathrm{C}$ will be read to determine which interrupt caused the event.
- When bit 4 is set in Register 0x0C "SRC_LNDPRT" this is the indication that a new orientation has been detected.
- The interrupt source $(0 \times 0 C)$ register and the PL_Status $(0 \times 10)$ register are cleared and the new portrait/landscape detection can occur.

```
Interrupt void isr_KBI (void)
{
    //clear the interrupt flag
    CLEAR_KBI_INTERRUPT;
    //Determine the source of the interrupt by first reading the system
    interrupt register
    Int_SourceSystem=IIC_RegRead (0x0C);
    // Set up Case statement here to service all of the possible interrupts
    if ((Int_SourceSystem &0x10)==0x10)
    {
            //Perform an Action since Orientation Flag has been set
            //Read the PL State from the Status Register, clear the interrupt
    Int_SourcePL=IIC_RegRead(0x10); // PL Status Register
            //Update Image on Display Screen based on the data stored
    }
}
```


## nelated Documentation

The MMA845xQ device features and operations are described in a variety of reference manuals, user guides, and application notes. To find the most-current versions of these documents:

1. Go to the Freescale homepage at:
http://www.freescale.com/
2. In the Keyword search box at the top of the page, enter the device number MMA845xQ.
3. In the Refine Your Result pane on the left, click on the Documentation link.

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